

# SANYO Semiconductors

DATA SHEET

An ON Semiconductor Company

# SB1003M3-

Schottky Barrier Diode **30V, 1.0A Rectifier** 

# **Applications**

• High frequency rectification (switching regulators, converters, choppers)

### Features

- · Low switching noise
- · Low leakage current and high reliability due to highly reliable planar structure
- Ultrasmall package permitting applied sets to be small and slim (Mounting height 0.85mm)

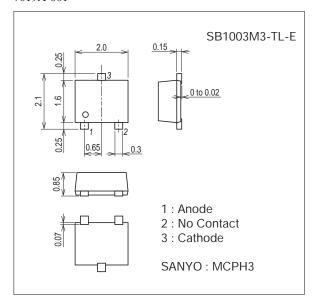
# **Specifications**

### Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Repetitive Peak Reverse Voltage	VRRM		30	V
Nonrepetitive Peak Reverse Surge Voltage	V <sub>RSM</sub>		35	V
Average Output Current	IO		1.0	А
Surge Forward Current	IFSM	50Hz sine wave, 1 cycle	10	А
Junction Temperature	Tj		-55 to +125	°C
Storage Temperature	Tstg		-55 to +125	°C

### Package Dimensions

unit : mm (typ) 7019A-001



### Product & Package Information

: MCPH3

• JEITA, JEDEC

• Package

C

: SC-70, SOT-323

Marking

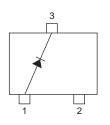
• Minimum Packing Quantity : 3,000 pcs./reel

### Packing Type : TL

# 



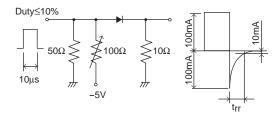
### **Electrical Connection**



### Electrical Characteristics at Ta=25°C

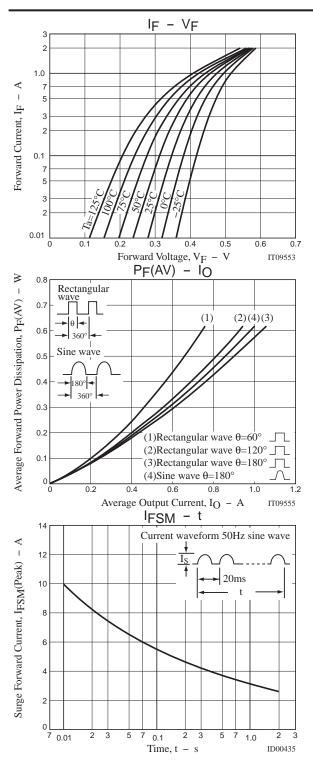
Parameter	Symbol	Conditions		11			
Parameter	Symbol	Conditions	min	typ	max	Unit	
Reverse Voltage	VR	IR=0.5mA	30			V	
	V <sub>F</sub> 1	IF=0.7A		0.45	0.50	V	
Forward Voltage	V <sub>F</sub> 2	IF=1.0A		0.48	0.53	V	
Reverse Current	IR	V <sub>R</sub> =16V			15	μΑ	
Interterminal Capacitance	С	V <sub>R</sub> =10V, f=1MHz		27		pF	
Reverse Recovery Time	t <sub>rr</sub>	IF=IR=100mA, See specified Test Circuit.			10	ns	
Thermal Resistance	Dth/i a)1	When mounted in Cu-foiled area of		94.7		°C/W	
	Rth(j-a)1	0.72mm <sup>2</sup> ×0.03mm on glass epoxy substrate	94.7			C/W	
	Rth(j-a)2	Rth(j-a)2 When mounted on ceramic substrate (500mm <sup>2</sup> ×0.8mm)				°C / W	

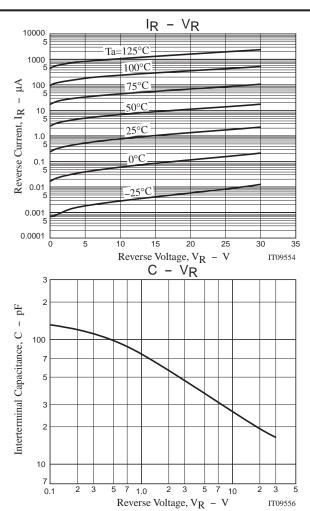
# trr Test Circuit



### **Ordering Information**

5				
Device	Package	Shipping	memo	
SB1003M3-TL-E	MCPH3	3,000pcs./reel	Pb Free	





### Taping Specification SB1003M3-TL-E

1. Packing Format

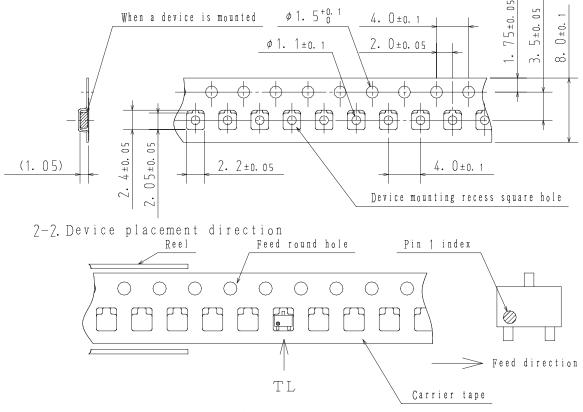
Package Name	Carrier Tape	Maximun Number of devices contained (pcs)			Packing format			
	Туре	Reel	Inner box	Outer box	Inner BOX (C-1)			Outer BOX (A-7)
MCPH3	МСРНЗ	3,000	15,000	90,000	5 ree	els containe	ed	6 inner boxes contained
					Dime	nsions:mm (	external)	Dimensions:mm (external)
					18	$3 \times 72 \times$	185	440×195×210
			Reel	label, I	Inner	box label		box label
Packing met	h o d			(u 1	nit:r	nm)	The for	label at the time of factory shipments, m of a label may change in physical ution process.
°			<	(	59	>	<	108
	Туре				00000	) ) 		TYPE CODE
						m		QTY 0,000 PCS LEAD FREE *
	///// Quan	tıty	(Z)	II IIIII IIIIIII Special		AD FREE *		LOT OCCOCCO
	Orig	in	> A:	* Z 0 7 2 2 SSEMBLY:**** (	005310 DIFFUSIO	  C*   :*****)	.     L	
			NOTE	· (1)		i		*2CIAL *20722005310C*   \$\$SEMBLY:*****(DIFFUSION:*****)
	∖ Reel la	bel	Th	e LEAD FI				nat the surface
			- tr	eatment	ot the	terminal i	s lead fi	сее,
				Label		JEITA	Phase	
				LEAD FRH	EE 3	JΕΙΤΑ Ρ	hase 3A	

LEAD FREE 4

JEITA Phase 3

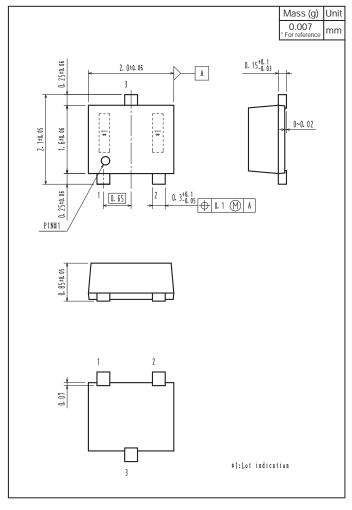
# 2. Taping configuration

2-1. Carrier tape size (unit:mm)

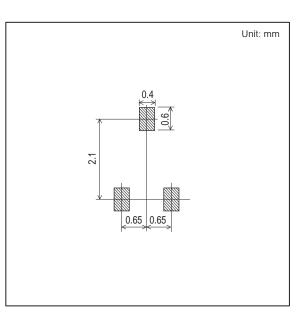


Those with pin 1 index on the feed hole side  $\cdots \cdots TL$ 

# Outline Drawing SB1003M3-TL-E



# Land Pattern Example



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